### **Features**

- Utilizes the ARM7TDMI<sup>™</sup> ARM Thumb Processor Core
  - High-performance 32-bit RISC Architecture
  - High-density 16-bit Instruction Set
  - Leader in MIPS/Watt
  - Embedded ICE (In-circuit Emulation)
- 2K Bytes Internal RAM
- Fully-programmable External Bus Interface (EBI)
  - Maximum External Address Space of 64M Bytes
  - Up to 8 Chip Selects
  - Software Programmable 8/16-bit External Data Bus
- Multi-processor Interface (MPI)
  - High-performance External Processor Interface
  - 512 x 16-bit Dual-port RAM
- 8-channel Peripheral Data Controller
- 8-level Priority, Individually Maskable, Vectored Interrupt Controller
  - 5 External Interrupts, Including a High-priority, Low-latency Interrupt Request
- 58 Programmable I/O Lines
- 6-channel 16-bit Timer/Counter
  - 6 External Clock Inputs
  - 2 Multi-purpose I/O Pins per Channel
- 3 USARTs
  - 2 Dedicated Peripheral Data Controller (PDC) Channels per USART
  - Support for Up to 9-bit Data Transfers
- Master/Slave SPI Interface
  - 2 Dedicated Peripheral Data Controller (PDC) Channels
  - 8- to 16-bit Programmable Data Length
  - 4 External Slave Chip Selects
- Programmable Watchdog Timer
- Power Management Controller (PMC)
  - CPU and Peripherals Can Be Deactivated Individually
- IEEE 1149.1 JTAG Boundary-scan on All Active Pins
- Fully Static Operation: 0 Hz to 25 MHz (12 MHz at 1.8V)
- 1.8V to 3.6V Core Operating Voltage Range
- 2.7V to 5.5V I/O Operating Voltage Range
- -40°C to +85°C Operating Temperature Range
- Available in a 176-lead TQFP Package

## Description

The AT91M63200 is a member of the Atmel AT91 16/32-bit microcontroller family which is based on the ARM7TDMI processor core.

This processor has a high-performance 32-bit RISC architecture with a high-density 16-bit instruction set and very low power consumption. In addition, a large number of internally banked registers result in very fast exception handling, making the device ideal for real-time control applications. The AT91 ARM-based MCU family also features Atmel's high-density, in-system programmable, nonvolatile memory technology.

The AT91M63200 has a direct connection to off-chip memory, including Flash, through the External Bus Interface.

The Multi-processor Interface (MPI) provides a high-performance interface with an external coprocessor or a high bandwidth peripheral.

The AT91M63200 is manufactured using the Atmel high-density CMOS technology. By combining the ARM7TDMI microcontroller core with on-chip SRAM, a multi-processor interface and a wide range of peripheral functions on a monolithic chip, the AT91M63200 provides a highly-flexible and cost-effective solution to many compute-intensive multi-processor applications.



# AT91 ARM<sup>®</sup> Thumb<sup>®</sup> Microcontrollers

# AT91M63200 Summary







# Pin Configuration

Pin	AT91M63200				
1	GND				
2	GND				
3	NCS0				
4	NCS1				
5	NCS2				
6	NCS3				
7	NLB/A0				
8	A1				
9	A2				
10	A3				
11	A4				
12	A5				
13	A6				
14	A7				
15	VDDIO				
16	GND				
17	A8				
18	A9				
19	A10				
20	A11				
21	A12				
22	A13				
23	A14				
24	A15				
25	A16				
26	A17				
27	A18				
28	A19				
29	VDDIO				
30	GND				
31	A20/CS7				
32	A21/CS6				
33	A22/CS5				
34	A23/CS4				
35	D0				
36	D1				
37	D2				
38	D3				
39	D4				
40	D5				
41	D6				
42	D7				
43	VDDCORE				
44	VDDIO				

Pin	AT91M63200
45	GND
46	GND
47	D8
48	D9
49	D10
50	D11
51	D12
52	D13
53	D14
54	D15
55	PB19/TCLK0
56	PB20/TIOA0
57	PB21/TIOB0
58	PB22/TCLK1
59	VDDIO
60	GND
61	PB23/TIOA1
62	PB24/TIOB1
63	PB25/TCLK2
64	PB26/TIOA2
65	PB27/TIOB2
66	PA0/TCLK3
67	PA1/TIOA3
68	PA2/TIOB3
69	PA3/TCLK4
70	PA4/TIOA4
71	PA5/TIOB4
72	PA6/TCLK5
73	VDDIO
74	GND
75	PA7/TIOA5
76	PA8/TIOB5
77	PA9/IRQ0
78	PA10/IRQ1
79	PA11/IRQ2
80	PA12/IRQ3
81	PA13/FIQ
82	PA14/SCK0
83	PA15/TXD0
84	PA16/RXD0
85	PA17/SCK1
86	PA18/TXD1/NTRI
87	VDDCORE
88	VDDIO

Pin	AT91M63200				
89	GND				
90	GND				
91	PA19 / RXD1				
92	PA20 / SCK2				
93	PA21 / TXD2				
94	PA22 / RXD2				
95	PA23 / SPCK				
96	PA24/MISO				
97	PA25/MOSI				
98	PA26/NPCS0/NSS				
99	PA27/NPCS1				
100	PA28/NPCS2				
101	PA29/NPCS3				
102	MPI_A1				
103	VDDIO				
104	GND				
105	MPI_A2				
106	MPI_A3				
107	MPI_A4				
108	MPI_A5				
109	MPI_A6				
110	MPI_A7				
111	MPI_A8				
112	MPI_A9				
113	MPI_NCS				
114	MPI_RNW				
115	MPI_BR				
116	MPI_BG				
117	VDDIO				
118	GND				
119	MPI_D0				
120	MPI_D1				
121	MPI_D2				
122	MPI_D3				
123	MPI_D4				
124	MPI_D5				
125	MPI_D6				
126	MPI_D7				
127	MPI_D8				
128	MPI_D9				
129	MPI_D10				
130	MPI_D11				
131	VDDCORE				
132	VDDIO				

Pin	AT91M63200
133	GND
134	GND
135	MPI_D12
136	MPI_D13
137	MPI_D14
138	MPI_D15
139	PB0/MPI_NOE
140	PB1/MPI_NLB
141	PB2/MPI_NUB
142	PB3
143	PB4
144	PB5
145	PB6
146	PB7
147	VDDIO
148	GND
149	PB8
150	PB9
151	PB10
152	PB11
153	PB12
154	PB13
155	PB14
156	PB15
157	PB16
158	PB17/MCKO
159	NWDOVF
160	MCKI
161	VDDIO
162	GND
163	PB18/BMS
164	JTAGSEL
165	TMS
166	TDI
167	TDO
168	TCK
169	NTRST
170	NRST
171	NWAIT
172	NOE/NRD
173	NWE/NWR0
174	NUB/NWR1
175	VDDCORE
176	VDDIO

# **Pin Description**

Module	Name Function		Туре	Active Level	Comments
	A0 - A23	Address Bus	Output	_	All valid after reset
	D0 - D15	Data Bus	I/O	_	
	CS4 - CS7	Chip Select	Output	High	A23 - A20 after reset
	NCS0 - NCS3	Chip Select	Output	Low	
	NWR0	Lower Byte 0 Write Signal	Output	Low	Used in Byte Write option
	NWR1	Lower Byte 1 Write Signal	Output	Low	Used in Byte Write option
EBI	NRD	Read Signal	Output	Low	Used in Byte Write option
	NWE	Write Enable	Output	Low	Used in Byte Select option
	NOE	Output Enable	Output	Low	Used in Byte Select option
	NUB	Upper Byte Select (16-bit SRAM)	Output	Low	Used in Byte Select option
	NLB	Lower Byte Select (16-bit SRAM)	Output	Low	Used in Byte Select option
	NWAIT	Wait Input	Input	Low	
	BMS	Boot Mode Select	Input	_	Sampled during reset
	MPI_NCS	Chip Select	Input	Low	
	MPI_RNW	Read Not Write Signal	Input	_	
	MPI_BR	Bus Request From External Processor	Input	High	
MPI	MPI_BG	Bus Grant To External Processor	Output	High	
	MPI_NOE	Output Enable	Input	Low	
	MPI_NLB	Lower Byte Select	Input	Low	
	MPI_NUB	Upper Byte Select	Input	Low	
	MPI_A1 - MPI_A9	Address Bus	Input	_	
	MPI_D0 - MPI_D15	Data Bus	I/O	_	
410	IRQ0 - IRQ3	External Interrupt Request	rnal Interrupt Request Input - PIO-controlled		PIO-controlled after reset
AIC	FIQ	Fast External Interrupt Request	Input	_	PIO-controlled after reset
	TCLK0 - TCLK5	Timer External Clock	Input	_	PIO-controlled after reset
Timer	TIOA0 - TIOA5	Multipurpose Timer I/O Pin A	I/O	_	PIO-controlled after reset
	TIOB0 - TIOB5	Multipurpose Timer I/O Pin B	I/O	_	PIO-controlled after reset
	SCK0 - SCK2	External Serial Clock	I/O	_	PIO-controlled after reset
USART	TXD0 - TXD2	Transmit Data Output	Output	_	PIO-controlled after reset
	RXD0 - RXD2	Receive Data Input	Input	_	PIO-controlled after reset
	SPCK	SPI Clock	I/O	_	PIO-controlled after reset
	MISO	Master In Slave Out	I/O	_	PIO-controlled after reset
SPI	MOSI	Master Out Slave In	I/O	_	PIO-controlled after reset
	NSS	Slave Select	Input	Low	PIO-controlled after reset
	NPCS0 - NPCS3	Peripheral Chip Select	Output	Low	PIO-controlled after reset
DIO	PA0 - PA29	Programmable I/O Port A	I/O	_	Input after reset
PIO	PB0 - PB27	Programmable I/O Port B	I/O	_	Input after reset
WD	NWDOVF	Watchdog Timer Overflow	Output	Low	Open-drain
Clask	MCKI	Master Clock Input	Input	_	Schmitt trigger
Clock	MCKO	Master Clock Output	Output	_	
Reset	NRST	Hardware Reset Input	Input	Low	Schmitt trigger, internal pull-up

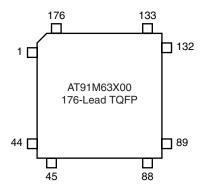




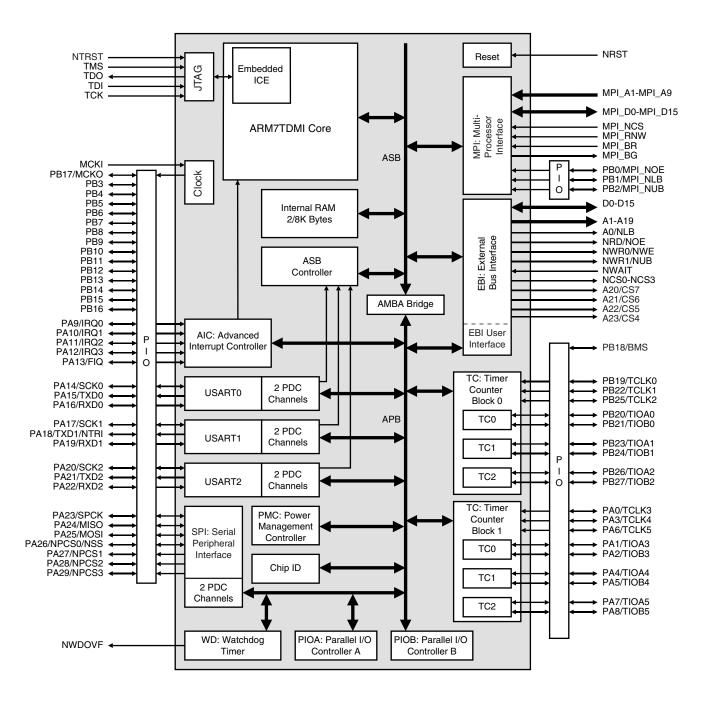
# **Pin Description (Continued)**

	N		-	Active	
Module	Name	Function	Type	Level	Comments
JTAG/ICE	JTAGSEL	Selects between JTAG and ICE Mode	Input	_	High enables IEEE 1149.1 JTAG Boundary-scan Low enables ARM Standard ICE debug
	TMS	Test Mode Select	Input	_	Schmitt trigger, internal pull-up
	TDI	Test Data In	Input	_	Schmitt trigger, internal pull-up
	TDO	Test Data Out	Output	_	
	TCK	Test Clock	Input	_	Schmitt trigger, internal pull-up
	NTRST	Test Reset Input	Input	Low	Schmitt trigger, internal pull-up
	VDDIO	I/O Power	Power	_	3V or 5V nominal supply
Power	VDDCORE	Core Power	Power	_	2.0V or 3V nominal supply
	GND	Ground	Ground	_	
Emulation	NTRI	Tri-state Mode Enable	Input	Low	Sampled during reset

Figure 1. Pin Configuration (Top View)



## **Block Diagram**







### **Architectural Overview**

The AT91M63200 architecture consists of two main buses, the Advanced System Bus (ASB) and the Advanced Peripheral Bus (APB). The ASB is designed for maximum performance. It interfaces the processor with the on-chip 32-bit memories and the external memories and devices by means of the External Bus Interface (EBI). The APB is designed for accesses to on-chip peripherals and is optimized for low power consumption. The AMBA™ Bridge provides an interface between the ASB and the APB.

An on-chip Peripheral Data Controller (PDC) transfers data between the on-chip USARTs/SPI and the on- and off-chip memories without processor intervention. Most importantly, the PDC removes the processor interrupt handling overhead and significantly reduces the number of clock cycles required for a data transfer. It can transfer up to 64K contiguous bytes without reprogramming the starting address. As a result, the performance of the microcontroller is increased and the power consumption reduced.

The AT91M63200 peripherals are designed to be easily programmable with a minimum number of instructions. Each peripheral has a 16-Kbyte address space allocated in the upper 3M bytes of the 4-Gbyte address space. Except for the interrupt controller, the peripheral base address is the lowest address of its memory space. The peripheral register set is composed of control, mode, data, status and interrupt registers.

To maximize the efficiency of bit manipulation, frequently written registers are mapped into three memory locations. The first address is used to set the individual register bits, the second resets the bits and the third address reads the value stored in the register. A bit can be set or reset by writing a one to the corresponding position at the appropriate address. Writing a zero has no effect. Individual bits can thus be modified without having to use costly read-modify-write and complex bit manipulation instructions.

All of the external signals of the on-chip peripherals are under the control of the Parallel I/O Controller. The PIO Controller can be programmed to insert an input filter on each pin or generate an interrupt on a signal change. After reset, the user must carefully program the PIO Controller in order to define which peripheral signals are connected with off-chip logic.

The ARM7TDMI processor operates in little-endian mode in the AT91M63200 microcontroller. The processor's internal architecture and the ARM and Thumb instruction sets are described in the ARM7TDMI datasheet. The memory map and the on-chip peripherals are described in detail in the AT91M63200 datasheet. Electrical and mechanical characteristics are documented in the AT91M63200 Electrical Characteristics datasheet.

The ARM Standard In-circuit-Emulation debug interface is supported via the ICE port of the AT91M63200 via the JTAG/ICE port when JTAGSEL is low. IEEE JTAG Boundary-scan is supported via the JTAG/ICE port when JTAGSEL is high.

### **PDC: Peripheral Data Controller**

The AT91M63200 has an 8-channel PDC dedicated to the three on-chip USARTs and to the SPI. One PDC channel is connected to the receiving channel and one to the transmitting channel of each peripheral.

The user interface of a PDC channel is integrated in the memory space of each USART channel and in the memory space of the SPI. It contains a 32-bit address pointer register and a 16-bit count register. When the programmed data is transferred, an end-of-transfer interrupt is generated by the corresponding peripheral. See the USART section and the SPI section for more details on PDC operation and programming.

#### **Power Supplies**

The AT91M63200 has two kinds of power supply pins:

- VDDCORE pins, which power the chip core
- VDDIO pins, which power the I/O lines

This allows core power consumption to be reduced by supplying it with a lower voltage than the I/O lines. The VDDCORE pins must never be powered at a voltage greater than the supply voltage applied to the VDDIO pins.

Typical supported voltage combinations are shown in the following table:

Pins	Typical Supply Voltages							
VDDCORE	3.0V or 3.3V	3.0V or 3.3V	2.0V					
VDDIO	5.0V	3.0V or 3.3V	3.0V or 3.3V					

### **EBI: External Bus Interface**

The EBI generates the signals that control the access to the external memory or peripheral devices. The EBI is fully programmable and can address up to 64M bytes. It has eight chip selects and a 24-bit address bus, the upper four bits of which are multiplexed with a chip select.

The 16-bit data bus can be configured to interface with 8or 16-bit external devices. Separate read and write control signals allow for direct memory and peripheral interfacing.

The EBI supports different access protocols, allowing single clock cycle memory accesses.

The main features are:

- · External memory mapping
- Up to 8 chip select lines
- 8- or 16-bit data bus
- · Byte write or byte select lines
- · Remap of boot memory
- · Two different read protocols
- · Programmable wait state generation
- · External wait request
- · Programmable data float time

## **MPI: Multi-processor Interface**

The AT91M63200 features a second bus interface that is dedicated to parallel data exchange with an external processing device. The MPI features a 1-Kbyte dual-port RAM memory and memory access arbitration logic. The ARM processor core and the external processor can both read and write to the dual-port RAM memory.

## **AIC: Advanced Interrupt Controller**

The AT91M63200 has an 8-level priority, individually maskable, vectored interrupt controller. This feature substantially reduces the software and real-time overhead in handling internal and external interrupts.

The interrupt controller is connected to the NFIQ (fast interrupt request) and the NIRQ (standard interrupt request) inputs of the ARM7TDMI processor. The processor's NFIQ line can only be asserted by the external fast interrupt request input: FIQ. The NIRQ line can be asserted by the interrupts generated by the on-chip peripherals and the external interrupt request lines: IRQ0 to IRQ3.

An 8-level priority encoder allows the customer to define the priority between the different NIRQ interrupt sources. Internal sources are programmed to be level sensitive or edge triggered. External sources can be programmed to be positive or negative edge triggered or high- or low-level sensitive.

#### PIO: Parallel I/O Controller

The AT91M63200 features 58 programmable I/O lines. 14 pins on the AT91M63200 are dedicated as general-purpose I/O pins. Other I/O lines are multiplexed with on-chip peripheral I/O signals in order to optimize the use of available package pins. The I/O lines are controlled by two separate and identical PIO controllers (PIOA and PIOB). Each PIO controller also provides an internal interrupt signal to the Advanced Interrupt Controller (AIC).

## USART: Universal Synchronous/Asynchronous Receiver/Transmitter

The AT91M63200 provides three identical, full-duplex, universal synchronous/asynchronous receiver/transmitters that interface to the APB and are connected to the Peripheral Data Controller.

The main features are:

- Programmable baud rate generator
- · Parity, framing and overrun error detection
- · Line break generation and detection
- Automatic echo, local loopback and remote loopback channel modes
- Multi-drop mode: address detection and generation
- Interrupt generation
- Two dedicated peripheral data controller channels
- 5-, 6-, 7-, 8- and 9-bit character length

## **SPI: Serial Peripheral Interface**

The AT91M63200 features an SPI, which provides communication with external devices in master or slave mode.

The SPI has four external chip selects that can be connected to up to 15 devices. The data length is programmable, from 8- to 16-bit.

As for the USART, a 2-channel PDC is used to move data directly between memory and the SPI without CPU intervention for maximum real-time processing throughput.





## TC: Timer/Counter

The AT91M63200 features two identical Timer/Counter blocks, each containing three identical 16-bit timer counter channels. Each channel can be independently programmed to perform a wide range of functions, including frequency measurement, event counting, interval measurement, pulse generation, delay timing and pulsewidth modulation.

Each Timer/Counter channel has three external clock inputs, five internal clock inputs, and two multi-purpose input/output signals that can be configured by the user. Each channel drives an internal interrupt signal that can be programmed to generate processor interrupts via the Advanced Interrupt Controller (AIC).

Each Timer Counter block features two global registers that act upon all three TC channels. The Block Control Register allows the three channels to be started simultaneously with the same instruction. The Block Mode Register defines the external clock inputs for each Timer/Counter channel, allowing them to be chained.

## **WD: Watchdog Timer**

The AT91M63200 features an internal watchdog timer, which can be used to guard against system lock-up if the software becomes trapped in a deadlock.

## **PMC: Power Management Controller**

The Power Management Controller allows optimization of power consumption. The PMC enables/disables the clock inputs to most of the peripherals as well as to the ARM processor core.

When the ARM core clock is disabled, the current instruction is processed before the clock is stopped. The clock can be re-enabled by any enabled interrupt or by a hardware reset.

When a peripheral clock is disabled, the clock is immediately stopped. When the clock is re-enabled, the peripheral resumes action where it left off.

Due to the static nature of the design, the contents of the on-chip RAM and registers for which the clocks are disabled remain unchanged.

## SF: Special Function

The AT91M63200 provides registers that implement the following special functions:

- · Chip identification
- RESET status

# Ordering Information

Max Speed (MHz)	Operating Power Supply Range	Ordering Code	RAM (Bytes)	Package	Operating Temperature Range
25	2.7V to 3.6V (Core) 2.7V to 5.5V (I/Os)	AT91M63200-25AI	014	TOED 170	Industrial (-40°C to 85°C)
12	1.8V to 3.6V (Core) 2.7V to 3.6V (I/Os)	AT91M63200-12AI-1.8	2K	TQFP 176	Industrial (-40°C to 85°C)



# Package Outline TQFP 176

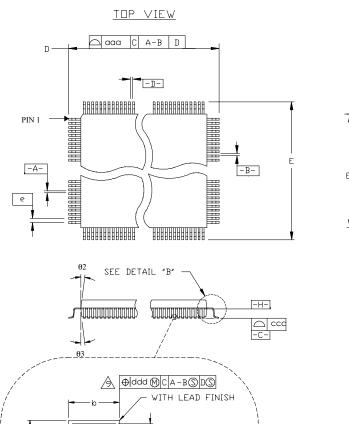
## **Common Dimensions (mm)**

Symbol	Min	Nom	Max
С	0.09		0.2
c1	0.09		0.16
L	0.45	0.6	0.75
L1		1.00 REF	
R2	0.08		0.2
R1	0.08		
S	0.2		
q	0°	3.5°	7°
θ1	0°		
θ2	11°	12°	13°
θ3	11°	12°	13°
А			1.6
A1	0.05		0.15
A2	1.35	1.4	1.45
	Tolerances of fo	orm and position	
aaa		0.2	
bbb		0.2	

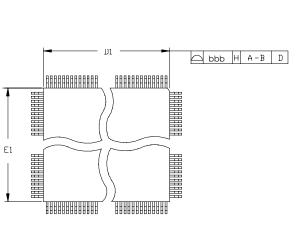
## **Lead Count Dimensions**

Pin	D/E	D1/E1		b b1							
Count	BSC	BSC	Min	Nom	Max	Min	Nom	Max	e BSC	ccc	ddd
176	26.0	24.0	0.17	0.22	0.27	0.17	0.2	0.23	0.50	0.10	0.08

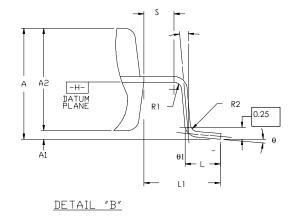
## **Package Drawing**



BASE METAL



BOTTOM VIEW





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